

**PDS540** 

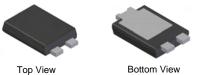
5A SCHOTTKY BARRIER RECTIFIER PowerDI<sup>®</sup>5

## Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: PowerDl<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.093 grams (approximate)





Note: Pins Left & Right must be electrically connected at the printed circuit board.

#### Ordering Information (Note 2)

Part Number	Case	Packaging
PDS540-13	PowerDI <sup>®</sup> 5	5000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes

2. For packaging details, go to our website at http://www.diodes.com.

### **Marking Information**



S540 = Product type marking code )'' = Manufacturers' code marking YYWW = Date code marking YY = Last digit of year (ex: 04 for 2004) WW = Week code (01 - 53) K = Factory Designator

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## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current (See also figure 5)	lo	5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	IFSM	150	А

## **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	R <sub>θJS</sub>	_	4.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 3)	R <sub>θJA</sub>	90	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 4)	R <sub>θ</sub> JA	65		°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	50	_	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to	o +150	°C

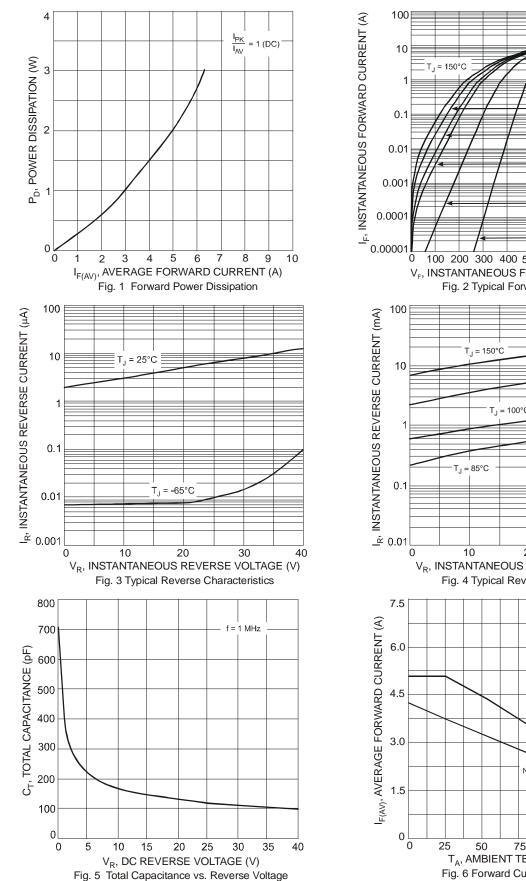
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	40	_	_	V	$I_R = 0.5 mA$
Forward Voltage		_	0.48	0.52	V	I <sub>F</sub> = 5A, T <sub>S</sub> = 25°C
	V	_	0.43	0.47		I <sub>F</sub> = 5A, T <sub>S</sub> = 125°C
	V <sub>F</sub>	—	0.57	0.65		I <sub>F</sub> = 10A, T <sub>S</sub> = 25°C
			0.55	0.59		I <sub>F</sub> = 10A, T <sub>S</sub> = 125°C
Reverse Leakage Current (Note 6)		_	0.015	0.25		$T_{S} = 25^{\circ}C, V_{R} = 40V$
	I <sub>R</sub>	_	3	15	mA	T <sub>S</sub> = 100°C, V <sub>R</sub> = 40V
		—	10	40		T <sub>S</sub> = 125°C, V <sub>R</sub> = 40V

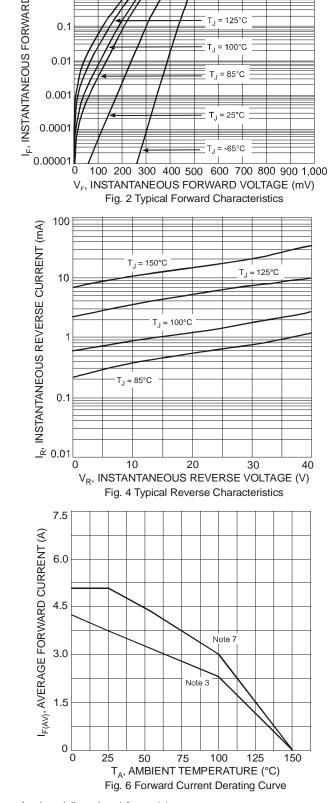
Notes:

FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
Short duration pulse test used to minimize self-heating effect.





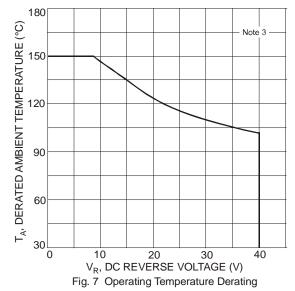
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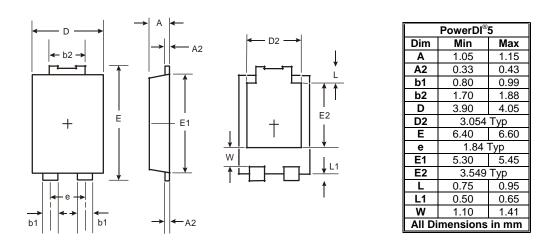
Notes: 7. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 6.5mm x 5.0mm. Anode pad dimensions 1.8mm x 1.1mm.

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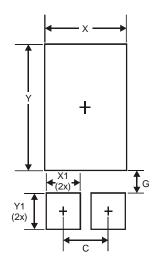




# **Package Outline Dimensions**



## **Suggested Pad Layout**



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400

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